



S/N 10/634,274

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Paul A. Farrar

Examiner: Brook Kebede

Serial No.: 10/634,274

Group Art Unit: 2823

Filed: August 5, 2003

Docket: 1303.110US1

Title: H2 PLASMA TREATMENT

**COMMUNICATION CONCERNING RELATED APPLICATION**

**MS RCE**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application in the above-identified patent application:

<u>Serial/Patent No.</u>	<u>Filing Date/Issue Date</u>	<u>Attorney Docket</u>	<u>Title</u>
11458195	July 18, 2006	303.664US6	STRUCTURES AND METHODS TO ENHANCE COPPER METALLIZATION

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

Respectfully submitted,

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Date 18 December 2006 By David R. Cochran  
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**CERTIFICATE UNDER 37 CFR 1.8:** The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS RCE, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 18 day of December, 2006.

USA Rosalene  
Name

Susan Rosalene  
Signature